

ACUROS[®] CQD[®] 1280L GigE SWIR Camera

ACUROS-1280-GigE-003

The ACUROS CQD L-Series SWIR cameras feature large sensor area, low angular dependence and a longer working distance for highly divergent emitters and collimated beams. Acuros cameras deliver high resolution, high dynamic range and very high detectivity imaging from 400 nm to 1700 nm. The L-Series cameras are designed for use in laser beam diagnostics, laser beam imaging and laser alignment applications by mitigating interference fringing sources.

Please see the Acuros eSWIR product line for expanded sensitivity capabilities from 400 nm to 2000 nm.

SPECIFICATIONS

Table 1. ELECTRO-OPTICAL SPECIFICATIONS

Parameter	Value/Description	
Sensor	ACUROS CQD sensor	
Temperature Stabilization	Single-stage thermo-electric cooler	
Sensor Array Format	1280 x 1024	
Resolution	1.31 MP (megapixel)	
Spectral Band	400–1700 nm	
Array Size	19.2 mm x 15.4 mm, 24.6 mm diagonal	
Pixel Pitch	15 μm x 15 μm	
Max Frame Rate at Full Resolution	88 fps (8 bit), 45 fps (10, 12, 14 bit)	
Pixel Operability	99.9% typical, 99.75% min	
Bit Depth	8, 10, 12, 14 bit selectable	
Integration Type	Snapshot global shutter	
Trigger	External TTL	
Integration Time	100 μs to 4 s	
Dynamic Range	70 dB typical	
Windowing & Windowing Frame Rate	Array centered. Scales inversely to window size	
Laser Beam Fringeless Operation	Yes	
Binning Arrays	2 x 2, 4 x 4	
Non-uniformity Correction	2-point non-uniformity correction	
Temporal Dark Noise	80/70/65 e- typical	
Quantum Efficiency	See typical QE curve (Figure 5)	



ORDERING INFORMATION

Part Number
ACUROS-1280-GigE-003

Features

- Large Sensor Size
- Short Working Distance for Highly Divergent Beams
- Low Angular Dependence
- Dynamic Range up to 70 dB
- Linear Photoresponse
- 1.2 MP Resolution
- TEC Cooling
- Low Noise
- GigE VisionVisible-SWIR

Applications

- Laser Beam Diagnostics
- Laser Beam Imaging
- Laser Alignment

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Table 2. ENVIRONMENTAL & POWER SPECIFICATIONS, TYPICAL PERFORMANCE

Parameter	Value/Description
Operating Case Temperature	−20 °C to +55 °C
Power Consumption	6.5-12 W depending on TEC settings
Power Supply Voltage	6–16 V dc. POE not supported
Regulatory Compliance	CE mark

Table 3. MECHANICAL SPECIFICATIONS

Parameter	Value/Description
Dimensions Excluding Lens	6.1 x 6.1 x 9.8 cm
Weight Excluding Lens	508 grams
Lens Mounts	Standard mount. Inquire for other options.
Power Connector	Hirose 12-pin, HR10A-10R-12PB (71)
Trigger Connector	BNC

Table 4. SOFTWARE AND USER INTERFACE

Parameter	Value/Description	
Software Development Kit	Windows GUI & Pleora eBUS SDK (Linux, Windows, macOS)	
GenlCam Compliance	Yes	
Interface	GigE Vision	

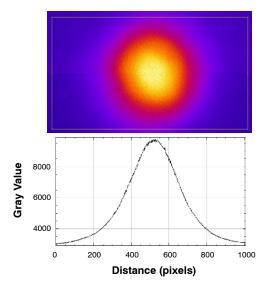


Figure 1. Lens Mount



Figure 2. GigE Vision Interface

ACUROS-1280-GigE-003



1550 NM Laser image and corresponding line file (false color added post image)

Figure 3. ACUROS CQD SWIR Camera Images of Laser

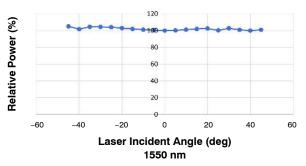


Figure 4. Angular Dependence Data

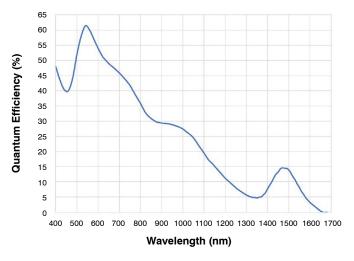


Figure 5. Typical QE Performance

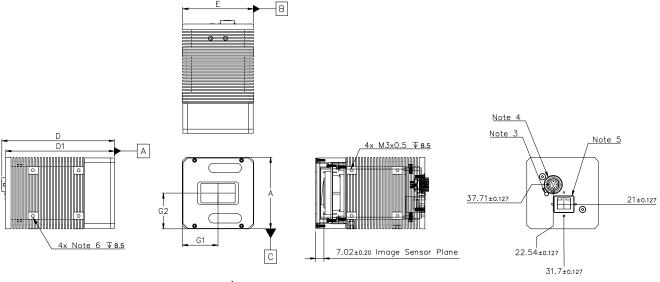
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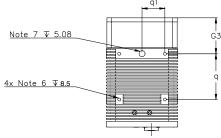
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39.11

19.50

MILLIMETERS

NOM.

MAX.

39.24

19.63

MIN.

38.98

19.37

DIM

q

q1

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M. 2018.
- 2. CONTROLLING DIMENSION: MILLIMETER
- 3. POWER INIDCATOR
- 4. HIROSE 12 PIN CONNECTOR
- 5. GigE CONNECTOR
- 6. M3X0.5 DEPTH ▼ 8.5.
- 7. 1/4-20 UNC DEPTH $\sqrt{5.08}$

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